

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

KEVIN J. MILLS et al.

Application No.: 10/009,452

Filed: June 10, 2002

For: HIGH-DENSITY REMOVABLE EXPANSION MODULE HAVING I/O AND SECOND-LEVEL, REMOVABLE

EXPANSION MEMORY

Customer No.: 20350

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed December 6, 2004, please enter the following amendments and remarks:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Amendments to the Drawings begin on page 16 of this paper and include both an attached replacement sheet and an annotated sheet showing changes.

Remarks/Arguments begin on page 17 of this paper.

An Appendix including amended drawing figures is attached following page 22 of this paper.

Confirmation No. 1849

Examiner:

Gopal C. Ray

Technology Center/Art Unit: 2111

AMENDMENT